

L Number	Hits	Search Text	DB	Time stamp
1	6	((("5094769") or ("5098609") or ("5167851")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:07
2	0	((("5094769") or ("5098609") or ("5167851")).PN.) and (compliant NEAR material NEAR metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 13:44
3	0	((("5094769") or ("5098609") or ("5167851")).PN.) and (compliant NEAR material)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 13:44
4	3	("3778287" "3885984" "4265775").PN.	USPAT	2003/06/05 13:51
5	19	5098609.URPN.	USPAT	2003/06/05 13:53
6	0	("thermal\$2NEARconduct\$NEARcompliantNEARmaterial").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:08
7	60	thermal\$2 NEAR conduct\$ NEAR compliant NEAR material	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:43
8	0	(thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) and (adhes\$3 NEAR metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:09
9	43	(thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) and metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:09
10	31	(thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) and adhes\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:09
11	0	(thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) WITH (adhes\$ NEAR5 metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:44
12	0	(thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) same (adhes\$ NEAR5 metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:44
13	0	(thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) WITH (adhes\$ NEAR metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:58
14	0	(thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) same (adhes\$ NEAR metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:45

15	0	((thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) same ((adhes\$ NEAR (layer film)) NEAR2 metal))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:46
16	2	((thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) and ((adhes\$ NEAR (layer film)) NEAR2 metal))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:58
17	3833	(adhes\$ NEAR (layer film)) NEAR2 metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:48
18	222	((adhes\$ NEAR (layer film)) NEAR2 metal) and ((thermal heat) NEAR conduct\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:51
19	24	((adhes\$ NEAR (layer film)) NEAR2 metal) and ((thermal heat) NEAR conduct\$3 NEAR material\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:51
20	60	((thermal\$2 NEAR conduct\$ NEAR compliant NEAR material))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 14:58
21	11	((thermal\$2 NEAR conduct\$ NEAR compliant NEAR material) WITH metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 15:01
22	43	((thermal\$2 NEAR conduct\$ NEAR compliant NEAR material)) and metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 15:01